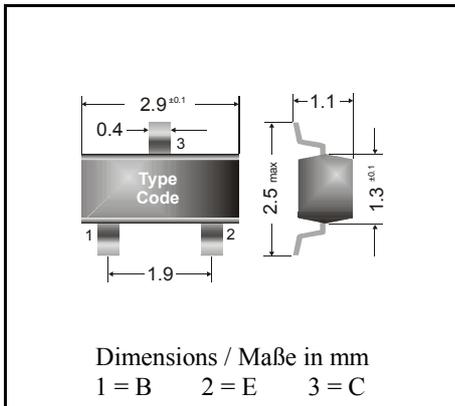


NPN

**Surface mount Si-Epitaxial Planar Transistors**  
**Si-Epitaxial Planar Transistoren für die Oberflächenmontage**

NPN



Power dissipation – Verlustleistung 250 mW

Plastic case SOT-23  
Kunststoffgehäuse (TO-236)

Weight approx. – Gewicht ca. 0.01 g

Plastic material has UL classification 94V-0  
Gehäusematerial UL94V-0 klassifiziertStandard packaging taped and reeled  
Standard Lieferform gegurtet auf Rolle**Maximum ratings ( $T_A = 25^\circ\text{C}$ )****Grenzwerte ( $T_A = 25^\circ\text{C}$ )**

|   |        |           | <b>BCX 19</b>        | <b>BCX 20</b> |
|---|--------|-----------|----------------------|---------------|
| Collector-Emitter-voltage                       | B open | $V_{CE0}$ | 45 V                 | 25 V          |
| Collector-Base-voltage                          | E open | $V_{CB0}$ | 50 V                 | 30 V          |
| Emitter-Base-voltage                            | C open | $V_{EB0}$ | 5 V                  |               |
| Power dissipation – Verlustleistung             |        | $P_{tot}$ | 250 mW <sup>1)</sup> |               |
| Collector current – Kollektorstrom (DC)         |        | $I_C$     | 500 mA               |               |
| Peak Collector current – Kollektor-Spitzenstrom |        | $I_{CM}$  | 1 A                  |               |
| Peak Base current – Basis-Spitzenstrom          |        | $I_{BM}$  | 200 mA               |               |
| Junction temperature – Sperrschichttemperatur   |        | $T_j$     | 150°C                |               |
| Storage temperature – Lagerungstemperatur       |        | $T_S$     | - 65...+ 150°C       |               |

**Characteristics ( $T_j = 25^\circ\text{C}$ )****Kennwerte ( $T_j = 25^\circ\text{C}$ )**

|  |             | <b>Min.</b> | <b>Typ.</b> | <b>Max.</b>     |
|--|-------------|-------------|-------------|-----------------|
| Collector-Base cutoff current – Kollektorreststrom                 |             |             |             |                 |
| $I_E = 0, V_{CB} = 20\text{ V}$                                    | $I_{CB0}$   | –           | –           | 100 nA          |
| $I_E = 0, V_{CB} = 20\text{ V}, T_j = 150^\circ\text{C}$           | $I_{CB0}$   | –           | –           | 5 $\mu\text{A}$ |
| Emitter-Base cutoff current – Emitterreststrom                     |             |             |             |                 |
| $I_C = 0, V_{EB} = 5\text{ V}$                                     | $I_{EB0}$   | –           | –           | 100 nA          |
| Collector saturation volt. – Kollektor-Sättigungssp. <sup>2)</sup> |             |             |             |                 |
| $I_C = 500\text{ mA}, I_B = 50\text{ mA}$                          | $V_{CEsat}$ | –           | –           | 620 mV          |

<sup>1)</sup> Mounted on P.C. board with 3 mm<sup>2</sup> copper pad at each terminal  
 Montage auf Leiterplatte mit 3 mm<sup>2</sup> Kupferbelag (Löt-pad) an jedem Anschluß

<sup>2)</sup> Tested with pulses  $t_p = 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$  – Gemessen mit Impulsen  $t_p = 300\ \mu\text{s}$ , Schaltverhältnis  $\leq 2\%$

Characteristics ( $T_j = 25^\circ\text{C}$ )Kennwerte ( $T_j = 25^\circ\text{C}$ )

|   | Min.           | Typ.        | Max.                  |
|---|----------------|-------------|-----------------------|
| DC current gain – Kollektor-Basis-Stromverhältnis <sup>1)</sup>                             |                |             |                       |
| $V_{CE} = 1\text{ V}, I_C = 100\text{ mA}$   $h_{FE}$                                       | 100            | –           | 600                   |
| $V_{CE} = 1\text{ V}, I_C = 300\text{ mA}$   $h_{FE}$                                       | 70             | –           | –                     |
| $V_{CE} = 1\text{ V}, I_C = 500\text{ mA}$   $h_{FE}$                                       | 40             | –           | –                     |
| Base-Emitter voltage – Basis-Emitter-Spannung <sup>1)</sup>                                 |                |             |                       |
| $V_{CE} = 1\text{ V}, I_C = 500\text{ mA}$   $V_{BEon}$                                     | –              | –           | 1.2 V                 |
| Gain-Bandwidth Product – Transitfrequenz  |                |             |                       |
| $V_{CE} = 5\text{ V}, I_C = 10\text{ mA}, f = 100\text{ MHz}$   $f_T$                       | 100 MHz        | –           | –                     |
| Collector-Base Capacitance – Kollektor-Basis-Kapazität                                      |                |             |                       |
| $V_{CB} = 10\text{ V}, I_E = i_e = 0, f = 1\text{ MHz}$   $C_{CB0}$                         | –              | 5 pF        | –                     |
| Thermal resistance junction to ambient air<br>Wärmewiderstand Sperrschicht – umgebende Luft | $R_{thA}$      |             | 420 K/W <sup>2)</sup> |
| Recommended complementary PNP transistors<br>Empfohlene komplementäre PNP-Transistoren      | BCX 17, BCX 18 |             |                       |
| Marking – Stempelung  | BCX 19 = U1    | BCX 20 = U2 |                       |

<sup>1)</sup> Tested with pulses  $t_p = 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$  – Gemessen mit Impulsen  $t_p = 300\text{ }\mu\text{s}$ , Schaltverhältnis  $\leq 2\%$

<sup>2)</sup> Mounted on P.C. board with  $3\text{ mm}^2$  copper pad at each terminal  
Montage auf Leiterplatte mit  $3\text{ mm}^2$  Kupferbelag (Lötpad) an jedem Anschluß